

## Gels

# *Dow Corning*<sup>®</sup> 3-4207 Dielectric Tough Gel

### FEATURES

- Fast room temperature cure
- Two parts are blue and yellow and turn green when mixed
- Conditional primerless adhesion at room temperature
- Mechanical strength
- UL 94 V-1 Flammability Rating
- UV indicator for inspection.

### BENEFITS

- Fast RT cure, no ovens required
- Individual parts are blue and yellow to reduce potential for loading errors
- When properly mixed the gel is green
- Adhesion obtained at RT
- Toughened gel for additional mechanical strength
- Can be considered for uses requiring added flame resistance
- UV indicator allows for automated inspection

**2-part, translucent green, 1:1 mix ratio, fast ROOM TEMPERATURE cure tough gel with UV indicator, conditional primerless adhesion and good flame resistance**

### **TYPICAL PROPERTIES**

Specification Writers: These values are not intended for use in preparing specifications. Please contact your local Dow Corning sales office or your Global Dow Corning Connection before writing specifications on this product.

<b>Property</b>	<b>Unit</b>	<b>Value</b>
Viscosity (Part A)	cP	425
	mPa-sec	425
	Pa-sec	0.4
Viscosity (Part B)	cP	400
	mPa-sec	400
	Pa-sec	0.4
Agency Listing	-	UL 94-V1
Cure Time at 25°C	hrs	1.5
Gel Time @ 25C	minutes	9.8
Heat Cure Time @50°C	minutes	10
Heat Cure Time @ 100°C	minutes	3
Durometer Shore 00	-	59
Unprimed Adhesion - 180 Degree Peel Strength	ppi	3
	N/cm2	2
Shelf Life at 25°C	months	12

## DESCRIPTION

Under certain conditions in specific designs or applications, Dow Corning(R) 3-4207 Dielectric Tough Gel may lose adhesion. Full environmental exposure testing is recommended. For applications that require gels with added strength, there are tough or firm gel products. They can assist cost of ownership improvements due to their room temperature cure that requires no ovens though they can be heat accelerated if desired. These materials have enhanced chemical adhesion and cure slightly harder than standard gels, but may have limited applicability depending on processing conditions, device design, end-use environment and other conditions. Gels are a special class of encapsulants that cure to an extremely soft material. Gels cure in place to form cushioning, self-healing, resilient materials. Cured gels retain much of the stress relief and self-healing qualities of a liquid while providing the dimensional stability of an elastomer which is increasingly needed for delicate components. Gels have been used to isolate circuits from the harmful effects of moisture and other contaminants and provide electrical insulation for high voltages. Another use is providing stress relief to protect circuits and interconnections from thermal and mechanical stresses. Gels are usually applied in thick layers to totally encapsulate higher architectures. More recently, gels have found application in optoelectronics due to their stress relieving capability and high refractive index, as well as the stability of these properties over time.

## MIXING AND DE-AIRING

Some gels are supplied in bladder packs that avoid direct air contact with the liquid gel components, allowing use of air pressure over the pack in a pressure pot for dispensing. Do not apply air pressure directly to the liquid gel surface (without the bladder pack) as the gel can become supersaturated with air and bubbling can occur when the material is dispensed and cured. Use of bladder

packs prevents bubbling, maintains cleanliness and avoids gel contamination. Gels can be dispensed manually or by using one of the available types of meter mix equipment. Typically, the two components are of matched viscosities and are readily mixed with static or dynamic mixers, with automated meter-mix normally used for high volume processes. For low-volume applications, manual weighing and simple hand mixing may be appropriate. Inaccurate proportioning or inadequate mixing may cause localized or widespread problems affecting the gel properties or cure characteristics. If possible, the potential for entrapment and incorporation of gas (typically air) should be considered during design of the part and selection of a process to mix and dispense the gel. This is especially important with higher-viscosity and faster-curing gels. Degassing at >28 inches (10-20 mm) Hg vacuum may be necessary to ensure a void-free, protective layer.

## POT LIFE AND CURE RATE

Working time (or pot life) is the time required for the initial mixed viscosity to double at room temperature (RT). The cure reaction begins when Parts A and B are mixed. As the cure progresses, viscosity increases until the material becomes a soft gel. Cure conditions are shown in the typical properties table. Cure is defined as the time required for a specific gel to reach 90% of its final properties. Gels will reach a no-flow state prior to full cure. Addition-cure silicone gels may be RT and heat cure or exclusively heat cure. Adding heat accelerates the cure reaction. Additional time should be allowed for heating the part to near oven temperature. Cure schedules should be verified in each new application.

## USEFUL TEMPERATURE RANGES

For most uses, silicone elastomers should be operational over a

temperature range of -45 to 200°C (-49 to 392°F) for long periods of time. However, at both the low- and high temperature ends of the spectrum, behavior of the materials and performance in particular applications can become more complex and require additional considerations. For low-temperature performance, thermal cycling to conditions such as -55°C (-67°F) may be possible, but performance should be verified for your parts or assemblies. Factors that may influence performance are configuration and stress sensitivity of components, cooling rates and hold times, and prior temperature history. At the high-temperature end, the durability of the cured silicone elastomer is time and temperature dependent. As expected, the higher the temperature, the shorter the time the material will remain useable.

## COMPATIBILITY

Certain materials, chemicals, curing agents and plasticizers can inhibit the cure of addition cure adhesives. Most notable of these include: Organotin and other organometallic compounds, Silicone rubber containing organotin catalyst, Sulfur, polysulfides, polysulfones or other sulfur containing materials, unsaturated hydrocarbon plasticizers, and some solder flux residues. If a substrate or material is questionable with respect to potentially causing inhibition of cure, it is recommended that a small scale compatibility test be run to ascertain suitability in a given application. The presence of liquid or uncured product at the interface between the questionable substrate and the cured gel indicates incompatibility and inhibition of cure.

## REPAIRABILITY

In the manufacture of electronic devices, salvage or rework of damaged or defective units is often required. Removal of Dow Corning dielectric gels to allow necessary repairs can be assisted by using Dow Corning® OS Fluids. Additional information regarding these products is available from Dow Corning.

Digestive stripping agents, such as SU100 from Silicones Unlimited, can also be used. In addition, if only one component needs to be replaced, a soldering iron may be applied directly through the gel to remove the component. After work has been completed, the repaired area should be cleaned with forced air or a brush, dried, and patched with additional silicone gel.

## **PACKAGING**

In general, Dow Corning dielectric gels are available in batch-matched kits containing both Part A and Part B components. Packages that are typically available include 210-mL dual cartridges, one-gallon pails, five-gallon pails and 55-gallon drums. Not all gels may be available in all packages, and some additional packages and package sizes may be available.

## **STORAGE AND SHELF LIFE**

Shelf life is indicated by the "Use Before" date found on the product label. Refer to the product label for storage temperature requirements. Special precautions must be taken to prevent moisture from contacting these materials. Containers should be kept tightly closed and head or air space minimized. Partially filled containers should be purged with dry air or other gases, such as nitrogen. Exposure to moisture could reduce adhesion and cause bubbles to form.

## **HANDLING PRECAUTIONS PRODUCT SAFETY INFORMATION REQUIRED FOR SAFE USE IS NOT INCLUDED IN THIS**

**DOCUMENT. BEFORE HANDLING, READ PRODUCT AND MATERIAL SAFETY DATA SHEETS AND CONTAINER LABELS FOR SAFE USE, PHYSICAL AND HEALTH HAZARD INFORMATION. THE MATERIAL SAFETY DATA SHEET IS AVAILABLE ON THE DOW CORNING WEBSITE AT WWW.DOWCORNING.COM, OR FROM YOUR DOW CORNING REPRESENTATIVE, OR DISTRIBUTOR, OR BY CALLING YOUR GLOBAL DOW CORNING CONNECTION.**

## **HEALTH AND ENVIRONMENTAL INFORMATION**

To support Customers in their product safety needs, Dow Corning has an extensive Product Stewardship organization and a team of Product Safety and Regulatory Compliance (PS&RC) specialists available in each area. For further information, please see our website, [www.dowcorning.com](http://www.dowcorning.com) or consult your local Dow Corning representative.

## **LIMITATIONS**

This product is neither tested nor represented as suitable for medical or pharmaceutical uses.

## **LIMITED WARRANTY INFORMATION PLEASE READ CAREFULLY**

The information contained herein is offered in good faith and is believed to be accurate. However, because conditions and methods of use of our products are beyond our control, this information should not be used in substitution for customer's tests to

ensure that our products are safe, effective, and fully satisfactory for the intended end use. Suggestions of use shall not be taken as inducements to infringe any patent. Dow Corning's sole warranty is that our products will meet the sales specifications in effect at the time of shipment. Your exclusive remedy for breach of such warranty is limited to refund of purchase price or replacement of any product shown to be other than as warranted.

**DOW CORNING SPECIFICALLY DISCLAIMS ANY OTHER EXPRESS OR IMPLIED WARRANTY OF FITNESS FOR A PARTICULAR PURPOSE OR MERCHANTABILITY.**

**DOW CORNING DISCLAIMS LIABILITY FOR ANY INCIDENTAL OR CONSEQUENTIAL DAMAGES.**

## **For More Information**

To learn more about these and other products available from Dow Corning, please visit the Dow Corning Electronics website at [www.dowcorning.com/electronics](http://www.dowcorning.com/electronics).

*We help you invent the future.*™  
[www.dowcorning.com](http://www.dowcorning.com)